EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	("5891761").PN.	USPAT; USOCR	OR	OFF	2006/10/06 15:46
L2	533629	(@ad<"20020508") and (stack or chips or dies or (second near (chip or die)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 16:39
L3	1063	L2 and 324/71.5,719,765.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 16:39
L4 .	1050	l3 and (chip or die and "ic" or semiconductor)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 15:49
L5	7	(257/777.ccls. and 257/48.ccls.) and (@ad<"20020508")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 15:51
L6	1	(257/777.ccls. and 257/e21.521. ccls.) and (@ad<"20020508")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 15:51
L7	0	(257/777.ccls. and 257/e21.524. ccls.) and (@ad<"20020508")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 16:06
L8	171	l2 and 257/e21.521.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 16:06

L9	1	I2 and 257/e21.524.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 16:06
L10	5	257/777.ccls. and I3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 16:06
L11	0	324/71.5,719,765.ccls. and "438"". ""464".ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 17:49
L12	1	324/71.5,719,765.ccls. and "438/464.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 16:10
L13	1	324/71.5,719,765.ccls. and 438/464.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 16:10
L14	0	"438".ccls. and 438/11,14,18,142. ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 16:11
L15	0	"438""."""464".ccls. and 438/11,14, 18,142.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 16:11
L16	7	438/464.ccls. and 438/11,14,18, 142.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 16:13

L17	395	I3 and ((chip$1 or die$1) with (attach$3 or adhesive or adhere$1 or bond$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 16:40
L18	22	("6400173").URPN.	USPAT	OR	OFF	2006/10/06 16:38
L19	187	(MCM or multichip or (muti near chip))and 324/71.5,719,765.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 17:28
L20	150	L19 and (@ad<"20020508")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 17:31
L21	105	l20 and ((chip$1 or die$1) with (attach$3 or adhesive or adhere$1 or bond$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 16:41
L22	105	l20 and ((chip$1 or die$1) with (attach$3 or adhesive or adhere$1 or bond$3 or secure$1))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 16:42
L23	1	("5891761").PN.	USPAT; USOCR	OR	OFF	2006/10/06 16:42
L24	2	("0846675").PN.	USPAT; USOCR	OR	OFF	2006/10/06 17:26
L25	10	"846675"	USPAT	OR	OFF	2006/10/06 17:26
L26	9930	(((chip$ or die$1) with stack) or MCM or multichip or (muti near chip))and ("dut" or test or testing or kgd or burn)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 17:51
L27	9930	(((chip$ or die$1) with stack) or MCM or multichip or (muti near chip)) and ("dut" or test or testing or kgd or burn)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 17:50

L28	11	L27 and (@ad<"20020508") and 438/464.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 17:52
L29	1	L27 and (@ad<"20020508") and 438/for.142.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 17:36
L30	0	L27 and (@ad<"20020508") and 438/for.101.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 17:35
L31	64	L27 and (@ad<"20020508") and 438/11,14,18.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 17:39
L32	166	L27 and (@ad<"20020508") and 257/48,777.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 17:40
L33	158	L32 not L31	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 17:45
L34	1	("4589547").PN.	USPAT; USOCR	OR	OFF	2006/10/06 17:45
L35	9090	"324"/$.ccls. and ((substrate or interposer or board or pwb or pcb or carrier) with ("dut" or test or testing or kgd or burn))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 17:51
L36	657	L35 and (((chip$ or die$1) with stack) or MCM or multichip or (multi near chip))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 17:52

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L37	486	L36 and (@ad<"20020508")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/10/06 17:53